

3.0 x 1.0 mm High Temperature Series

Features

- \bullet 3.0 x 1.0 x 1.5 mm right angle SMD LED
- \bullet Ideal for indication on hand held products
- \bullet Low current operation
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- \bullet RoHS compliant

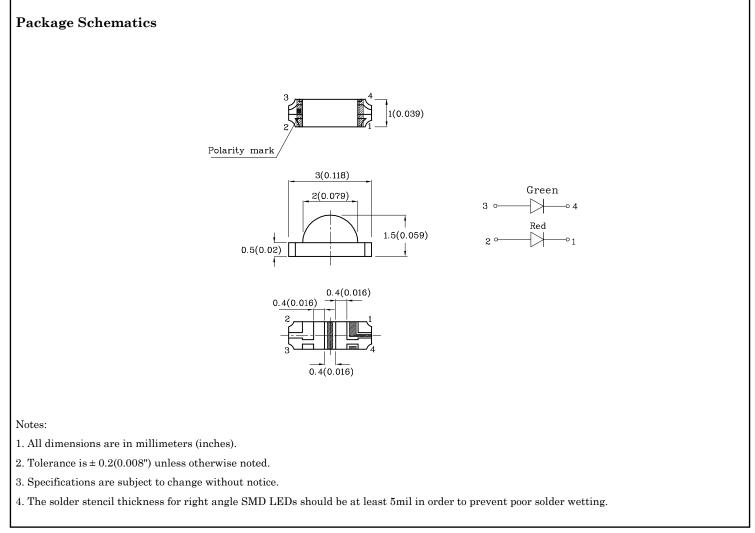




ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Applications

- Backlighting for tell-tale indicators
- \bullet Dashboard lighting
- Interior lighting (footwell, dome light, accent lighting, etc.)
- Exterior lighting (turn signals, side markers, CHMSL, etc.)
- Signs and signals
- Various applications requiring high temperature rating





Part Number: XZMDKVGX56W-HTA

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Part Number	Emitting Color (Material)	Luminous Intensity CIE127-2007* (I _F =20mA) mcd			Lens-color	Viewing Angle [1]
		Code.	min.	max.		2 θ 1/2
		Ν	120	200		
		Р	200	300		
	$\mathbf{D}_{\mathbf{r}} \mathbf{I} (\mathbf{A} \mathbf{I} \mathbf{C}_{\mathbf{r}} \mathbf{L}_{\mathbf{r}} \mathbf{D})$	Q	300	400		
XZMDKVGX56W-HTA —	Red (AlGaInP)	H*	55*	80*		
		M*	80*	120*		
		N*	120*	200*		1500
		F	20	40	Water Clear	150°
		G	40	55		
		Н	55	80		
	Green (AlGaInP)	F*	20*	40*		
		G*	40*	55*		
		H*	55*	80*		

Notes:

1. $\theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

* Luminous intensity value is in accordance with CIE127-2007 standards.

2. Listed bin codes represent the possible range for this LED. Actual bin codes received will be based upon production yields.

Absolute Maximum Ratings at Ta=25°C

		Va	Unit		
Parameter	Symbol	Red	Green	Unit	
Power dissipation	PD	75	75	mW	
Reverse Voltage	VR	5	5	V	
Junction temperature	TJ	115	115	°C	
Operating Temperature	Тор	-40 Te	°C		
Storage Temperature	Tstg	-40 Te	°C		
DC Forward Current	\mathbf{IF}	30	30 30		
Peak Forward Current [2]	IFM	185	150	mA	
Electrostatic Discharge Threshold (HBM)	3000 3000		V		
Thermal Resistance (Junction/ambient) [1]	$\operatorname{Rth} j$ -a	500	500 650		
Thermal Resistance (Junction / Solder point) [1]	$R {\tt th} {\tt j}{\tt \cdot} {\tt s}$	400	550	°C/W	

Notes:

1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad).

2. 1/10 Duty Cycle, 0.1ms Pulse Width.

3. A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033).

Mar 23,2023

XDSB9297 V4-X Layout: Maggie L.



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Electrical / Optical Characteristics at Ta=25°C

D. (G 1 1	C1 :		Value			TT •/
Parameter	Symbol	Chip	Code.	Min.	Typ.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF = 20 mA	λpeak	Red Green	-	-	645* 574*		nm
		Red	-	620*	-	640*	
			4*	565*	-	567*	nm
Dominant Wavelength CIE127-2007* IF = 20mA	λdom [1]	Green	5*	567*	-	569*	
			6*	569*	-	571*	
Spectral bandwidth at 50% Φ REL MAX IF = 20mA	Δλ	Red Green	-	-	28 20	-	nm
Forward Voltage IF = 20mA	VF [2]	Red Green	-	-	$1.95 \\ 2.1$	$2.5 \\ 2.5$	V
Reverse Current (VR = 5V)	Ir	Red Green	-	-	-	10 10	μΑ
Temperature coefficient of λ peak IF = 20mA, -10°C \leq T \leq 100°C	ТС\peak	Red Green	-	-	$0.14 \\ 0.12$	-	nm/°C
Temperature coefficient of λ dom IF = 20mA, -10°C $\leq T \leq 100°C$	TCλdom	Red Green	-	-	0.05 0.08	-	nm/°C
Temperature coefficient of VF $IF = 20mA, -10^{\circ}C \le T \le 100^{\circ}C$	TCv	Red Green	-	-	-1.9 -1.9	-	mV/°C

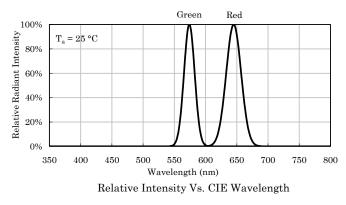
Notes:

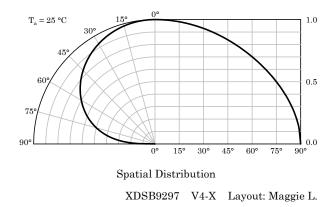
1. Wavelength : + / -1nm.

2. Forward Voltage: +/-0.1V.

 * Wavelength value is in accordance with CIE127-2007 standards.

3. Listed bin codes represent the possible range for this LED. Actual bin codes received will be based upon production yields.



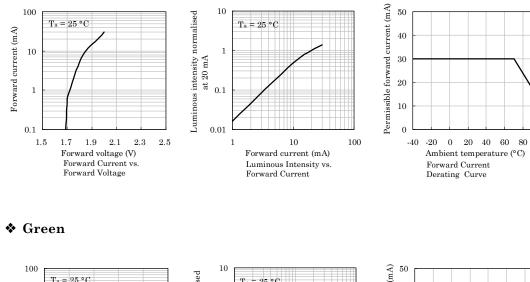


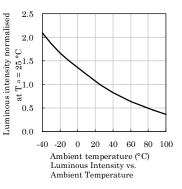


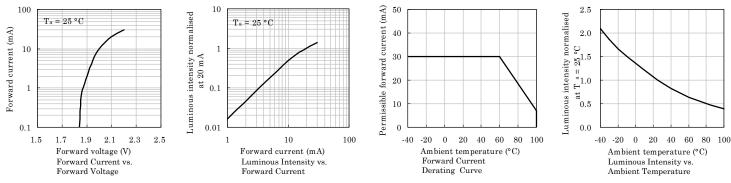
100

 $3.0 \ge 1.0 \text{ mm}$ High Temperature Series

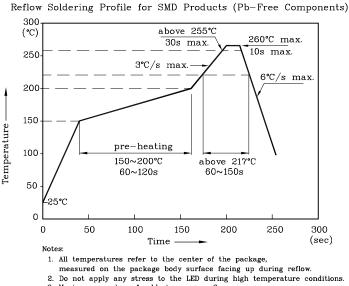
* Red







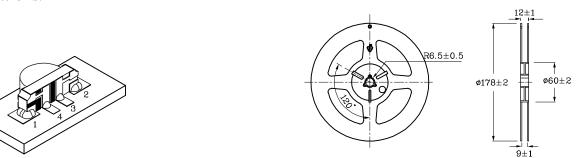
LED is recommended for reflow soldering and soldering profile is shown below.



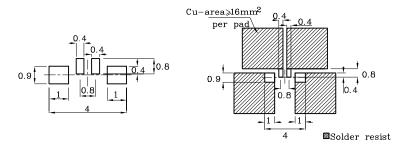
3. Maximum number of soldering passes: 2



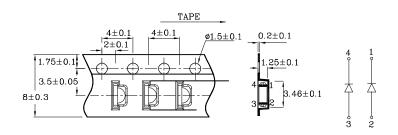
- The device has a single mounting surface. The device must be mounted according to the specifications.
- Reel Dimension (Units : mm)



Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15\%

3. Forward Voltage: +/-0.1V

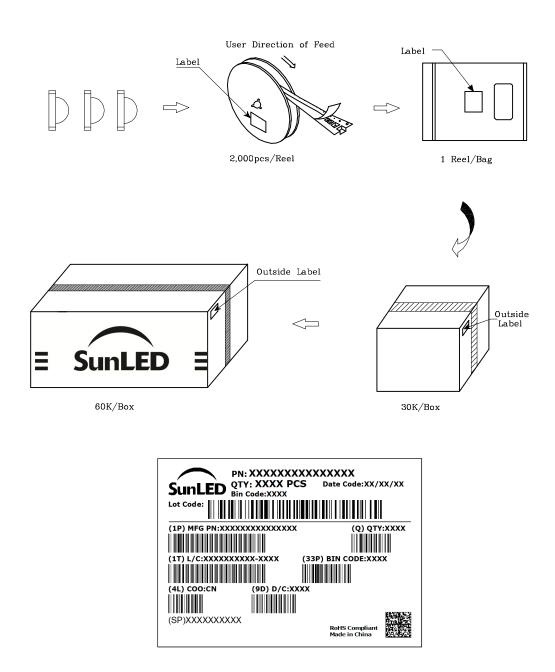
Note: Accuracy may depend on the sorting parameters.

Mar 23,2023



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PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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- 7. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below

Lot Tolerance Percent Defective (LTPD): 10%

No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	T_a = 25°C, I_F = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	T_{a} = 100°C, I_{F} = maximum rated current *	1,000 h	0 / 22
3	Low Temp. operating test	-	T_a = -40°C, I _F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	T_a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	$T_a = -40$ °C	1,000 h	0 / 22
6	High temp. & humidity storage test	EIAJ ED-4701/100(103)	$T_a = 60^{\circ}C, RH = 90\%$	1,000 h	0 / 22
7	High temp. & humidity operating test	EIAJ ED-4701/100(102)	$T_a = 60$ °C, RH = 90% I _F = maximum rated current *	1,000 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	$T_a = -40^{\circ}C(15min) \sim 100^{\circ}C(15min)$ $I_F = derated current at 100^{\circ}C$	1,000 cycles	0 / 22
10	Thermal shock test	-	$T_a = -40^{\circ}C(15min) \sim maximum rated$ Storage temperature(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	C = 100pF, R2 = 1.5KΩ V = 3000V (Red) V=3000V (Green)	Once each Polarity	0 / 22
12	Vibration test	-	$a = 196 \text{m/s}^2$, $f = 100 \sim 2 \text{KHz}$, t = 48min for all xyz axes	4 times	0 / 22

* : Refer to forward current vs. derating curve diagram

Criteria for Judging Damage

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	lv	IF = 20mA	Testing Min. Value <spec.min.value 0.5<="" td="" x=""></spec.min.value>
Forward Voltage	VF	IF = 20mA	Testing Max. Value ≥Spec.Max.Value x 1.2
Reverse Current	IR	VR = Maximum Rated Reverse Voltage	Testing Max. Value ≥Spec.Max.Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking